



## Clinical Applications of Orthodontic TSADs (Temporary Skeletal Anchorage Devices)

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### Message from the Guest Editor

Dear Colleagues,

This Special Issue aims to enumerate the clinical applications of various orthodontic temporary skeletal anchorage devices (TSADs). With their advent, the range of orthodontic camouflage treatments expanded through the selective application of TSADs to obtain the essential mechanics allowing the achievement of acceptable treatment results. Nowadays, TSADs are no longer new within the orthodontic field, but are essentially involved and designed in the orthodontic diagnosis and treatment planning processes to achieve a more effective tooth movement and better treatment results. Therefore, in this Special Issue, we seek several authors to contribute articles demonstrating the broad clinical applications of various TSADs.

Prof. Dr. Jong-Moon Chae  
*Guest Editor*





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## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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